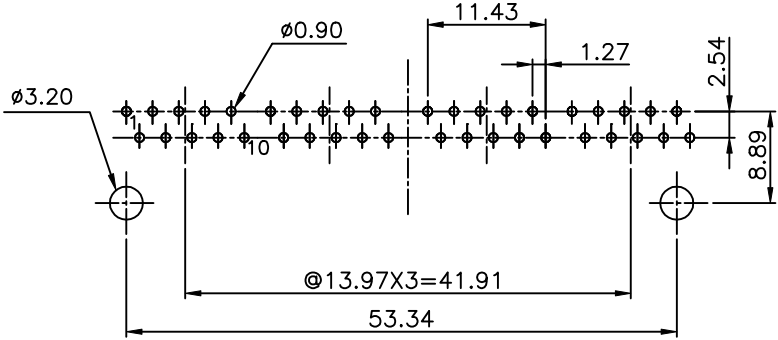
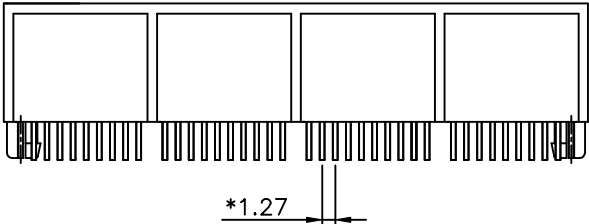
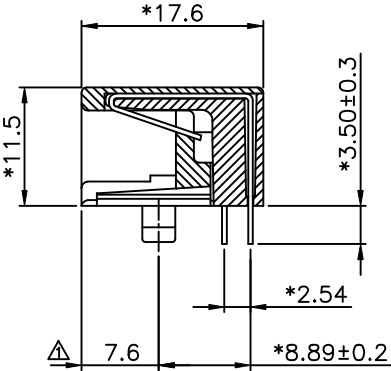
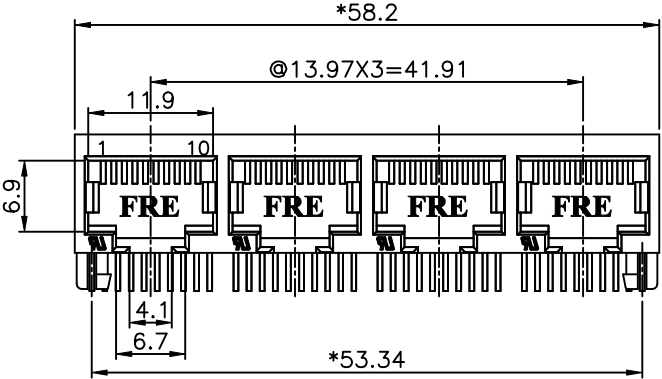


REVISION RECORD				
REV	ECO	DESCRIPTION	DRFT	CHKD
Δ		MODIFY DIM	ANKUE 8/2/05	



PC Board Layout Component Side Shown

NOTES:

ELECTRICAL:

1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 30 MILLIOHMS MAX.
4. INSULATION RESISTANCE : 1000 MEGOHMS MIN @ 500 VDC.
5. DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

MECHANICAL:

1. HOUSING MATERIAL: GLASS FILLED POLYESTER UL 94V-0.
2. CONTACT MATERIAL: PHOSPHOR BRONZE $\phi 0.46\text{mm}$.
3. PLATING : GOLD PLATING OVER NICKEL.
4. OPERATING LIFE : 750 CYCLES MIN.
5. PCB RETENTION PRE-SOLDER: 1 LB MIN.
6. PCB RETENTION POST-SOLDER: 10 LBS MIN.

ENVIRONMENTAL:

1. STORAGE: -40°C TO +85°C.
2. OPERATION: 0°C TO 70°C.
3. WAVE SOLDERING TEMPERATURE: 230~250° (3~5SECONDS).

MATES WITH MODULAR PLUG CONFORMING TO

FCC PART 68, SUBPART F.

CUL FILE NO. E163191

LEAD FREE PART NUMBER: E560X-00C06X-L

NO. OF CONTACT
8-8 CONTACTS
1- 10 CONTACTS

1- 3u" 2- 6u" 3-15u"
4-30u" 5-50u" 6-Pd20u"

DETACHED LISTS	MM (INCH)		DFTO ANKUE	DATE 6/1/05	FULL RISE ELECTRONIC CO., LTD					
	TOLERANCES EXCEPT AS NOTED		CHKD SAMMY	DATE 2005/8/2						
			MFO	DATE	TITLE 11.5 SIDE ENTRY PCB GANG JACK 10P					
			APPV LUSHENG	DATE 2005/8/2						
			MATERIAL :		DRAWING NO. GE563011-LC /PART NO. SEE NOTE					
	ANGLES ± 0.5		QTY :					SIZE A3		
			FINISH :					REV 1		
	THIRD ANGLE PROJECTION		SCALE : 2:1					DO NOT SCALE DRAWING		
								SHEET OF		